

# TPS37xx-Q1

## 双通道、低功耗、高精度电压检测器

### 1 特性

- 适用于汽车电子 应用
- 具有符合 AEC-Q100 的下列结果：
  - 器件温度 1 级：-40°C 至 125°C 的环境运行温度范围
  - 器件人体放电模式 (HBM) 静电放电 (ESD) 分类等级 H2
  - 器件组件充电模式 (CDM) ESD 分类等级 C4B
- 采用小型封装的双通道检测器
- 高精度阈值和滞后：1.0%
- 低静态电流：2μA（典型值）
- 可调节检测电压：最低至 1.2V
- 5% 和 10% 滞后选项
- 温度范围：-40°C 至 +125°C
- 推挽 (TPS3779-Q1) 和开漏 (TPS3780-Q1) 输出选项
- 采用 SOT-23 封装

### 2 应用

- 数字信号处理器 (DSP)、微控制器和微处理器
- 高级驾驶员辅助系统 (ADAS)
- 信息娱乐和仪表板
- 电源排序 应用

### 3 说明

TPS3779-Q1 和 TPS3780-Q1 属于高精度双通道电压检测器系列，同时拥有低功耗和小解决方案尺寸两大优势。SENSE1 和 SENSE2 输入包括滞后特性，可抑制短小毛刺脉冲，从而确保输出操作稳定而无错误触发。该器件提供了两种不同的出厂设置滞后选项：5% 或 10%。

TPS3779-Q1 和 TPS3780-Q1 配有可调节的 SENSEx 输入。这些输入可通过外部电阻分压器进行配置。当 SENSE1 和 SENSE2 输入上的电压低于下降阈值时，OUT1 和 OUT2 被分别驱动为低电平。当 SENSE1 和 SENSE2 上升到高于上升阈值时，OUT1 和 OUT2 分别变为高电平。

该器件的超低静态电流为 2μA（典型值），并且提供了一套精确且节省空间的电压检测解决方案，非常适合低功耗系统监视和便携式 输出电压电平信号。

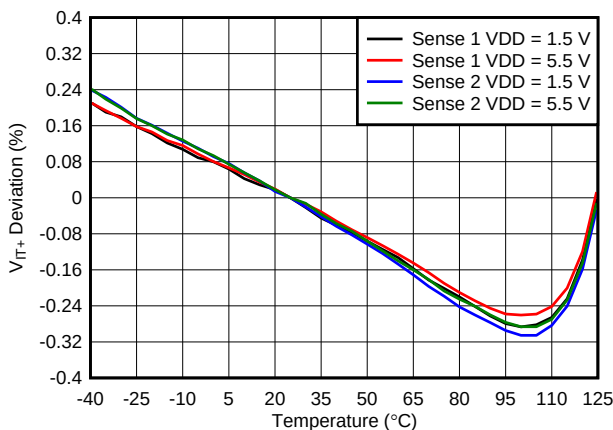
TPS3779-Q1 和 TPS3780-Q1 的工作电压范围为 1.5V 至 5.5V，工作温度范围为 -40°C 至 +125°C。

器件信息<sup>(1)</sup>

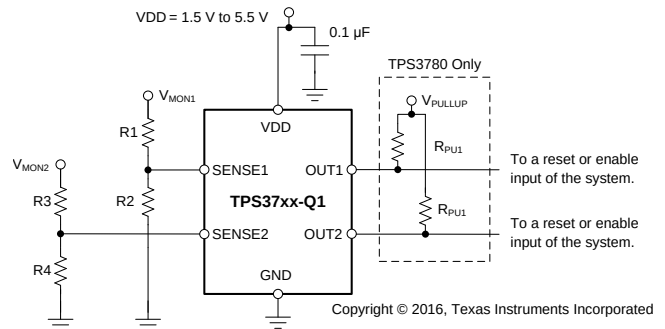
| 器件型号       | 封装         | 封装尺寸（标称值）       |
|------------|------------|-----------------|
| TPS37xx-Q1 | SOT-23 (6) | 2.90mm x 1.60mm |

(1) 如需了解所有可用封装，请见数据表末尾的可订购产品附录。

感测阈值 ( $V_{IT+}$ ) 偏差与温度间的关系



典型电路原理图



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## 4 修订历史记录

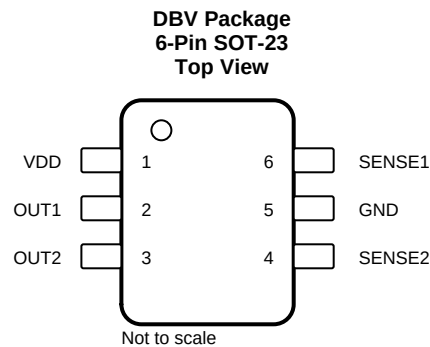
注：之前版本的页码可能与当前版本有所不同。

| <b>Changes from Original (June 2016) to Revision A</b>                                          | <b>Page</b> |
|-------------------------------------------------------------------------------------------------|-------------|
| • Added TPS3780A-Q1 row to <i>Device Comparison Table</i> .....                                 | <b>3</b>    |
| • Added TPS37xxA-Q1 row to $V_{IT-}$ parameter in <i>Electrical Characteristics</i> table ..... | <b>5</b>    |

## 5 Device Comparison Table

| PRODUCT     | HYSTERESIS (%) | OUTPUT     |
|-------------|----------------|------------|
| TPS3779B-Q1 | 5              | Push-pull  |
| TPS3779C-Q1 | 10             | Push-pull  |
| TPS3780A-Q1 | 0.5            | Open-drain |
| TPS3780B-Q1 | 5              | Open-drain |
| TPS3780C-Q1 | 10             | Open-drain |

## 6 Pin Configuration and Functions



### Pin Functions

| NAME   | NO. | I/O | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                          |
|--------|-----|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| GND    | 5   | —   | Ground                                                                                                                                                                                                                                                                                                                                                                                                               |
| OUT1   | 2   | O   | OUT1 is the output for SENSE1. OUT1 is asserted (driven low) when the voltage at SENSE1 falls below $V_{IT-}$ . OUT1 is deasserted (goes high) after SENSE1 rises higher than $V_{IT+}$ . OUT1 is a push-pull output for the TPS3779-Q1 and an open-drain output for the TPS3780-Q1. The open-drain device (TPS3780-Q1) can be pulled up to 5.5 V independent of VDD; a pullup resistor is required for this device. |
| OUT2   | 3   | O   | OUT2 is the output for SENSE2. OUT2 is asserted (driven low) when the voltage at SENSE2 falls below $V_{IT-}$ . OUT2 is deasserted (goes high) after SENSE2 rises higher than $V_{IT+}$ . OUT2 is a push-pull output for the TPS3779-Q1 and an open-drain output for the TPS3780-Q1. The open-drain device (TPS3780-Q1) can be pulled up to 5.5 V independent of VDD; a pullup resistor is required for this device. |
| SENSE1 | 6   | I   | This pin is connected to the voltage to be monitored with the use of an external resistor divider. When the voltage at this pin drops below the threshold voltage ( $V_{IT-}$ ), OUT1 is asserted.                                                                                                                                                                                                                   |
| SENSE2 | 4   | I   | This pin is connected to the voltage to be monitored with the use of an external resistor divider. When the voltage at this pin drops below the threshold voltage ( $V_{IT-}$ ), OUT2 is asserted.                                                                                                                                                                                                                   |
| VDD    | 1   | I   | Supply voltage input. Connect a 1.5-V to 5.5-V supply to VDD in order to power the device. Good analog design practice is to place a 0.1- $\mu$ F ceramic capacitor close to this pin (required for VDD < 1.5 V).                                                                                                                                                                                                    |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating junction temperature range (unless otherwise noted)<sup>(1)</sup>

|             |                                                   | MIN  | MAX       | UNIT |
|-------------|---------------------------------------------------|------|-----------|------|
| Voltage     | VDD                                               | −0.3 | 7         | V    |
|             | OUT1, OUT2 (TPS3779-Q1 only)                      | −0.3 | VDD + 0.3 |      |
|             | OUT1, OUT2 (TPS3780-Q1 only)                      | −0.3 | 7         |      |
|             | SENSE1, SENSE2                                    | −0.3 | 7         |      |
| Current     | OUT1, OUT2                                        |      | ±20       | mA   |
| Temperature | Operating junction, T <sub>J</sub> <sup>(2)</sup> | −40  | 125       | °C   |
|             | Storage, T <sub>stg</sub>                         | −65  | 150       |      |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) For low-power devices, the junction temperature rise above the ambient temperature is negligible; therefore, the junction temperature is considered equal to the ambient temperature (T<sub>J</sub> = T<sub>A</sub>).

### 7.2 ESD Ratings

|                    |                         | VALUE                                                   | UNIT  |
|--------------------|-------------------------|---------------------------------------------------------|-------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per AEC Q100-002 <sup>(1)</sup> | ±2000 |
|                    |                         | Charged-device model (CDM), per AEC Q100-011            | ±500  |

- (1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### 7.3 Recommended Operating Conditions

over operating junction temperature range (unless otherwise noted)

|                 |                                   | MIN | NOM | MAX       | UNIT |
|-----------------|-----------------------------------|-----|-----|-----------|------|
|                 | Power-supply voltage              | 1.5 |     | 5.5       | V    |
|                 | Sense voltage                     | 0   |     | 5.5       | V    |
|                 | Output voltage (TPS3779-Q1 only)  | 0   |     | VDD + 0.3 | V    |
|                 | Output voltage (TPS3780-Q1 only)  | 0   |     | 5.5       | V    |
| R <sub>PU</sub> | Pullup resistor (TPS3780-Q1 only) | 1.5 |     | 10,000    | kΩ   |
|                 | Current                           | −5  |     | 5         | mA   |
| C <sub>IN</sub> | Input capacitor                   |     | 0.1 |           | μF   |
| T <sub>J</sub>  | Junction temperature              | −40 | 25  | 125       | °C   |

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TPS3779-Q1, TPS3780-Q1 | UNIT |
|-------------------------------|----------------------------------------------|------------------------|------|
|                               |                                              | DBV (SOT-23)           |      |
|                               |                                              | 6 PINS                 |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 193.9                  | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 134.5                  | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 39.0                   | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 30.4                   | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 38.5                   | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | N/A                    | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 7.5 Electrical Characteristics

all specifications are over the operating temperature range of  $-40^{\circ}\text{C} < T_J < +125^{\circ}\text{C}$  and  $1.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$  (unless otherwise noted); typical values are at  $T_J = 25^{\circ}\text{C}$  and  $V_{DD} = 3.3\text{ V}$

| PARAMETER             |                                                     | TEST CONDITIONS                                                     | MIN                           | TYP   | MAX   | UNIT          |
|-----------------------|-----------------------------------------------------|---------------------------------------------------------------------|-------------------------------|-------|-------|---------------|
| V <sub>DD</sub>       | Input supply range                                  |                                                                     | 1.5                           |       | 5.5   | V             |
| V <sub>(POR)</sub>    | Power-on-reset voltage <sup>(1)</sup>               | V <sub>OL</sub> (max) = 0.2 V, I <sub>OL</sub> = 15 $\mu\text{A}$   |                               |       | 0.8   | V             |
| I <sub>DD</sub>       | Supply current (into VDD pin)                       | VDD = 3.3 V, no load                                                |                               | 2.09  | 5.80  | $\mu\text{A}$ |
|                       |                                                     | VDD = 5.5 V, no load                                                |                               | 2.29  | 6.50  |               |
| V <sub>IT+</sub>      | Positive-going input threshold voltage              | V <sub>(SENSEX)</sub> rising                                        |                               | 1.194 |       | V             |
|                       |                                                     |                                                                     | -1%                           |       | 1%    |               |
| V <sub>IT-</sub>      | Negative-going input threshold voltage              | V <sub>(SENSEX)</sub> falling                                       | TPS37xxA-Q1 (0.5% hysteresis) |       | 1.188 | V             |
|                       |                                                     |                                                                     | TPS37xxB-Q1 (5% hysteresis)   |       | 1.134 |               |
|                       |                                                     |                                                                     | TPS37xxC-Q1 (10% hysteresis)  |       | 1.074 |               |
|                       |                                                     | V <sub>(SENSEX)</sub> falling                                       | -1%                           |       | 1%    |               |
| I <sub>(SENSEX)</sub> | Input current                                       | V <sub>(SENSEX)</sub> = 0 V or VDD                                  | -15                           |       | 15    | nA            |
| V <sub>OL</sub>       | Low-level output voltage                            | VDD $\geq$ 1.5 V, I <sub>SINK</sub> = 0.4 mA                        |                               |       | 0.25  | V             |
|                       |                                                     | VDD $\geq$ 2.7 V, I <sub>SINK</sub> = 2 mA                          |                               |       | 0.25  |               |
|                       |                                                     | VDD $\geq$ 4.5 V, I <sub>SINK</sub> = 3.2 mA                        |                               |       | 0.30  |               |
| V <sub>OH</sub>       | High-level output voltage (TPS3779-Q1 only)         | VDD $\geq$ 1.5 V, I <sub>SOURCE</sub> = 0.4 mA                      | 0.8 VDD                       |       |       | V             |
|                       |                                                     | VDD $\geq$ 2.7 V, I <sub>SOURCE</sub> = 1 mA                        | 0.8 VDD                       |       |       |               |
|                       |                                                     | VDD $\geq$ 4.5 V, I <sub>SOURCE</sub> = 2.5 mA                      | 0.8 VDD                       |       |       |               |
| I <sub>IKG(OD)</sub>  | Open-drain output leakage current (TPS3780-Q1 only) | High impedance, V <sub>(SENSEX)</sub> = V <sub>(OUTX)</sub> = 5.5 V | -250                          |       | 250   | nA            |

(1) Outputs are undetermined below V<sub>(POR)</sub>.

## 7.6 Timing Requirements

typical values are at  $T_J = 25^\circ\text{C}$  and  $V_{DD} = 3.3\text{ V}$ ; SENSEx transitions between 0 V and 1.3 V

|                                                        | MIN | NOM | MAX | UNIT          |
|--------------------------------------------------------|-----|-----|-----|---------------|
| $t_{PD(r)}$ SENSEx (rising) to OUTx propagation delay  |     | 5.5 |     | $\mu\text{s}$ |
| $t_{PD(f)}$ SENSEx (falling) to OUTx propagation delay |     | 10  |     | $\mu\text{s}$ |
| $t_{SD}$ Startup delay <sup>(1)</sup>                  |     | 570 |     | $\mu\text{s}$ |

- (1) During power-on or when a  $V_{DD}$  transient is below  $V_{DD}(\text{min})$ , the outputs reflect the input conditions 570  $\mu\text{s}$  after  $V_{DD}$  transitions through  $V_{DD}(\text{min})$ .

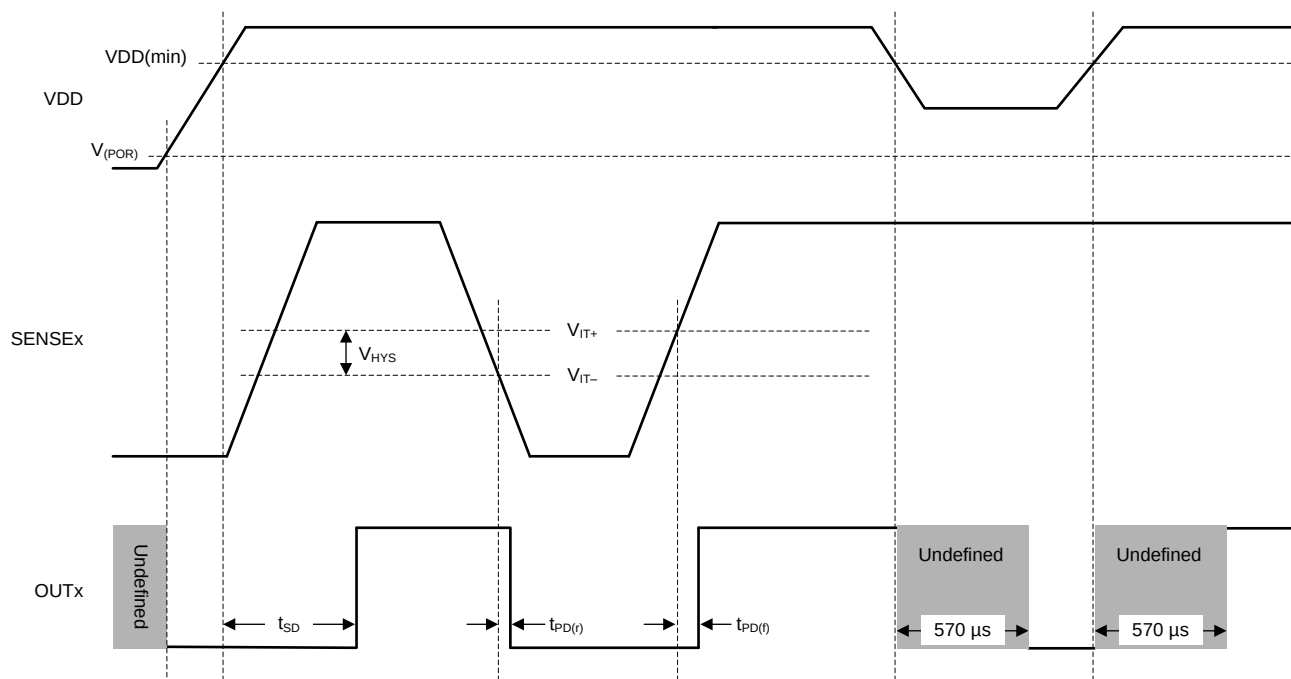


图 1. Timing Diagram

## 7.7 Typical Characteristics

at  $T_J = 25^\circ\text{C}$  with a 0.1- $\mu\text{F}$  capacitor close to VDD (unless otherwise noted)

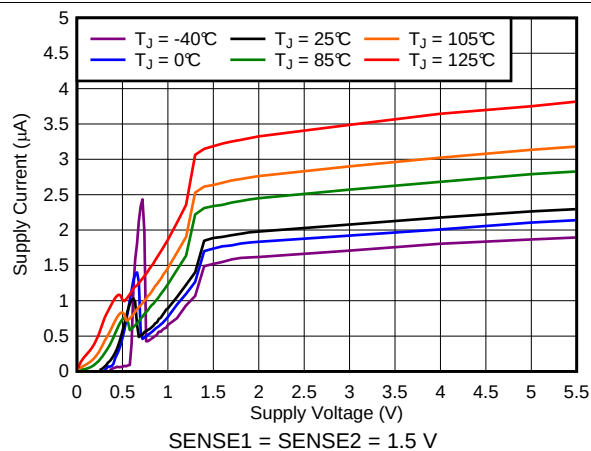


图 2. Supply Current vs Supply Voltage

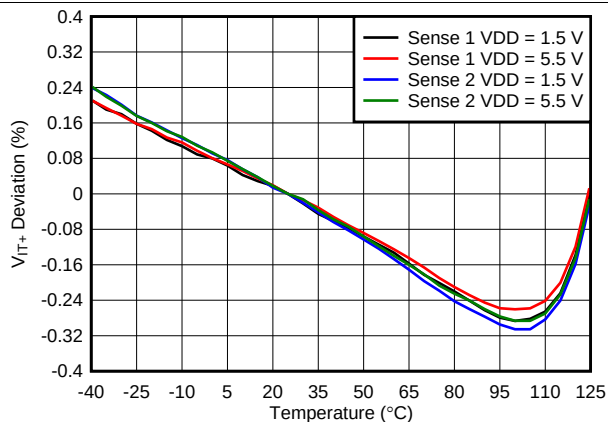


图 3. Sense Threshold ( $V_{IT+}$ ) Deviation vs Temperature

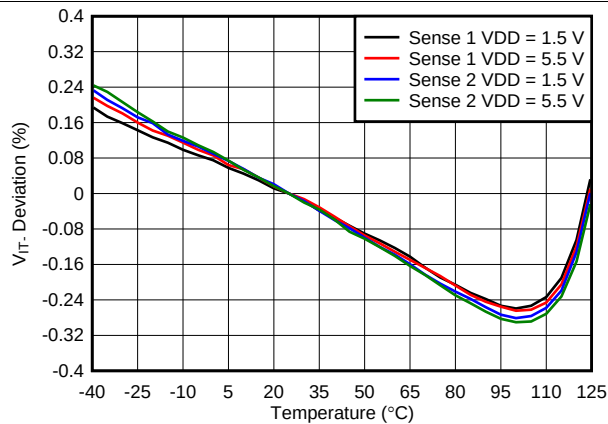


图 4. Sense Threshold ( $V_{IT-}$ ) Deviation vs Temperature

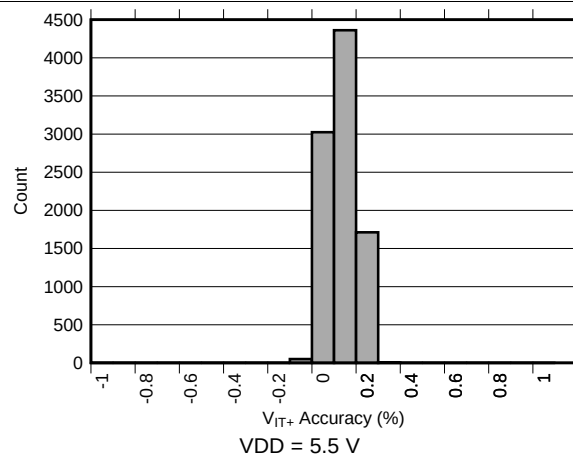


图 5. Sense Threshold ( $V_{IT+}$ )

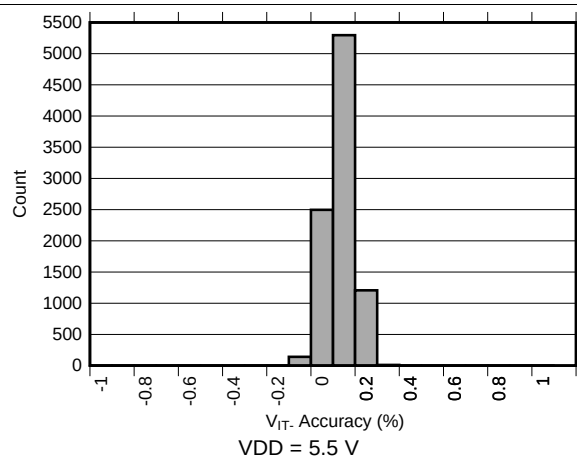


图 6. Sense Threshold ( $V_{IT-}$ )

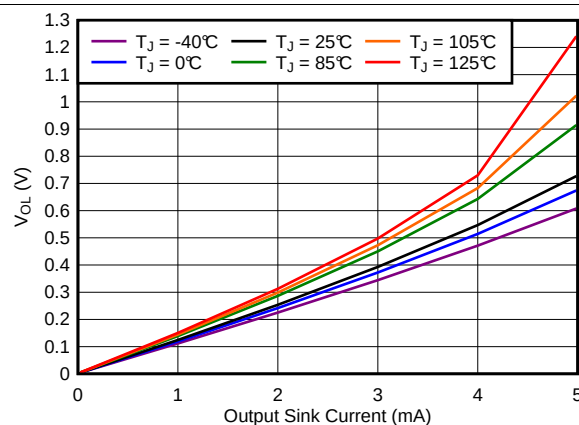


图 7. Output Voltage Low vs Output Current  
(VDD = 1.5 V)

## Typical Characteristics (接下页)

at  $T_J = 25^\circ\text{C}$  with a 0.1- $\mu\text{F}$  capacitor close to VDD (unless otherwise noted)

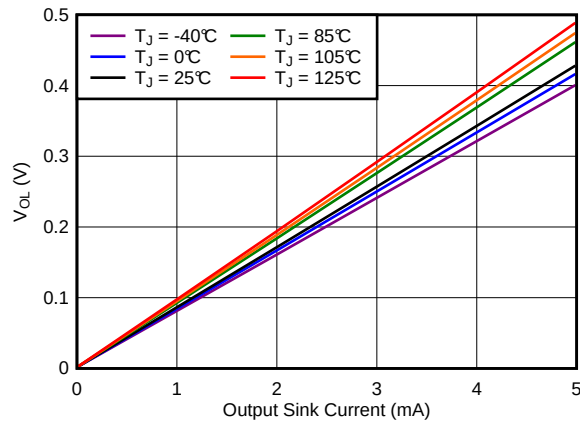


图 8. Output Voltage Low vs Output Current  
(VDD = 3.3 V)

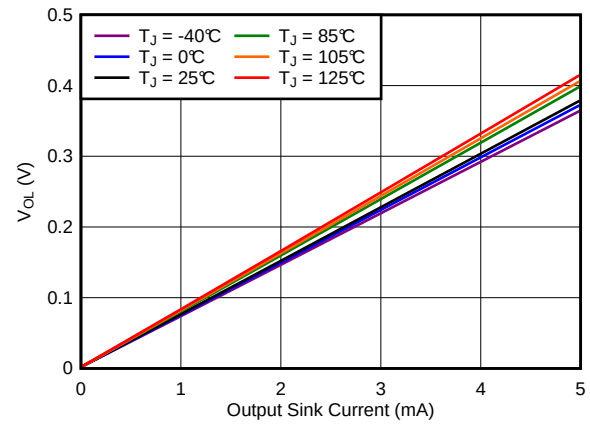


图 9. Output Voltage Low vs Output Current  
(VDD = 5.5 V)

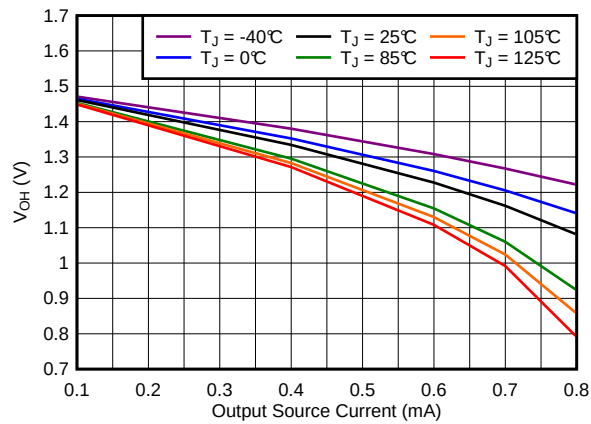


图 10. Output Voltage High vs Output Current  
(VDD = 1.5 V)

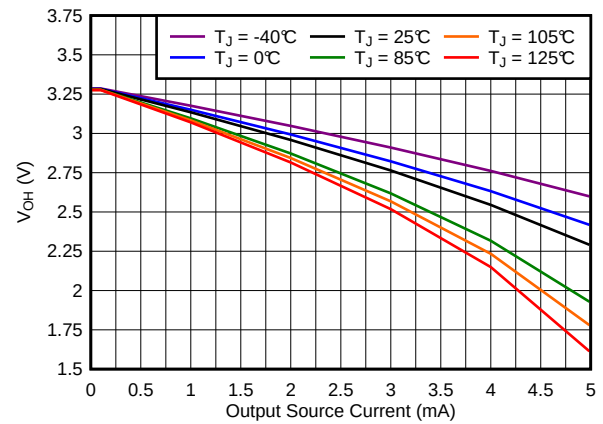


图 11. Output Voltage High vs Output Current  
(VDD = 3.3 V)

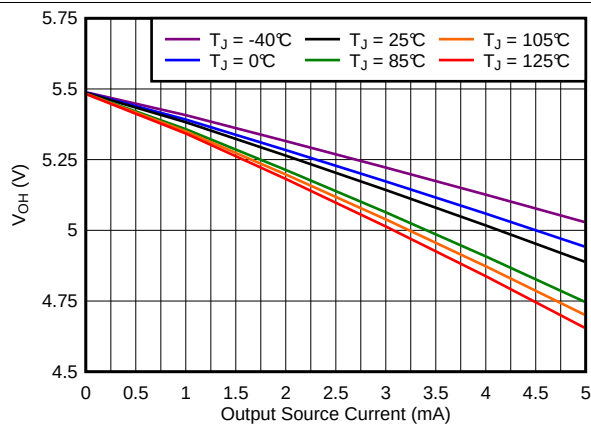


图 12. Output Voltage High vs Output Current  
(VDD = 5.5 V)

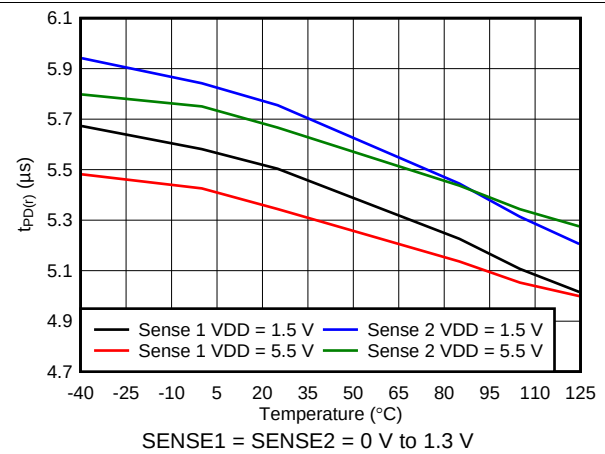


图 13. Propagation Delay from  
SENSEx High to Output High



## Typical Characteristics (接下页)

at  $T_J = 25^\circ\text{C}$  with a 0.1- $\mu\text{F}$  capacitor close to VDD (unless otherwise noted)

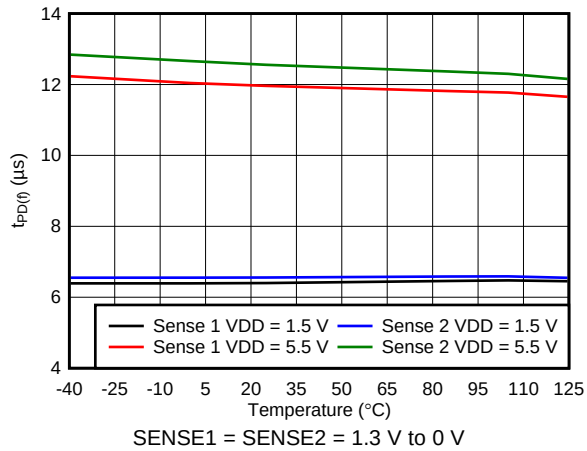


图 14. Propagation Delay from SENSEx Low to Output Low

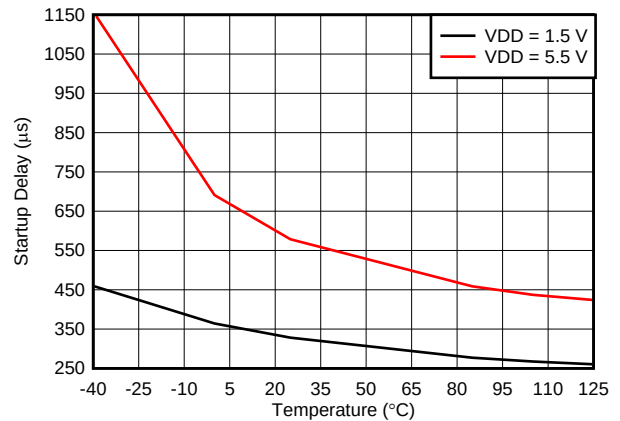


图 15. Startup Delay

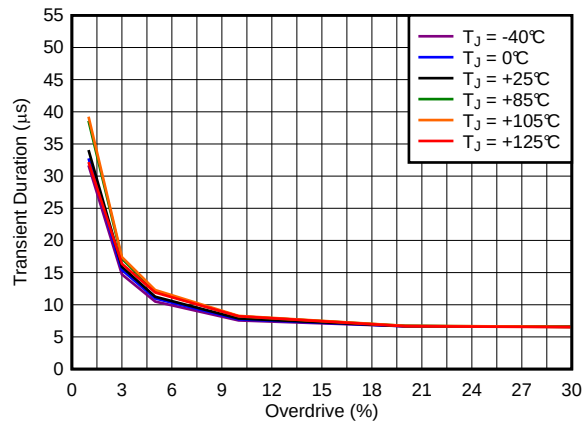


图 16. Minimum Transient Duration vs Overdrive (VDD = 1.5 V)

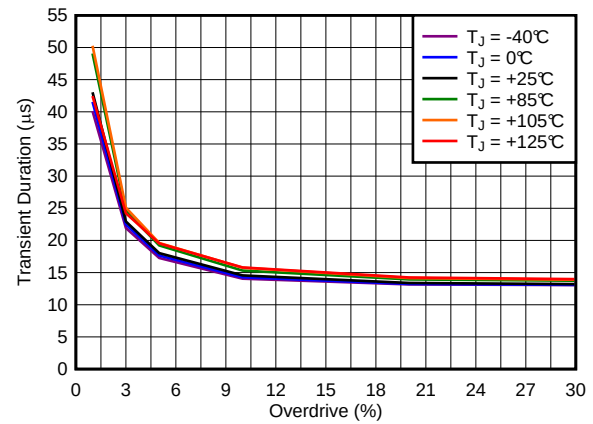


图 17. Minimum Transient Duration vs Overdrive (VDD = 5.5 V)

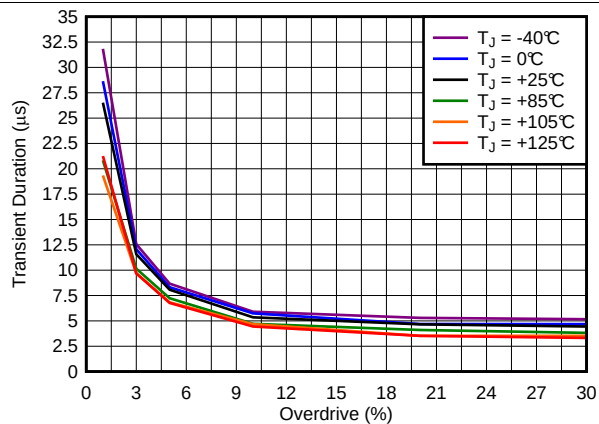


图 18. Minimum Transient Duration vs Overdrive (VDD = 1.5 V)

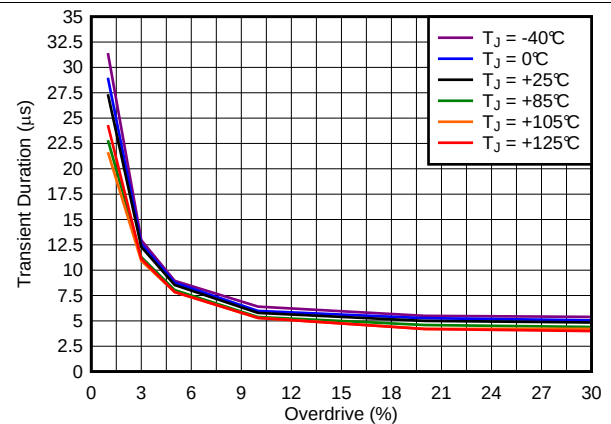


图 19. Minimum Transient Duration vs Overdrive (VDD = 5.5 V)

## 8 Detailed Description

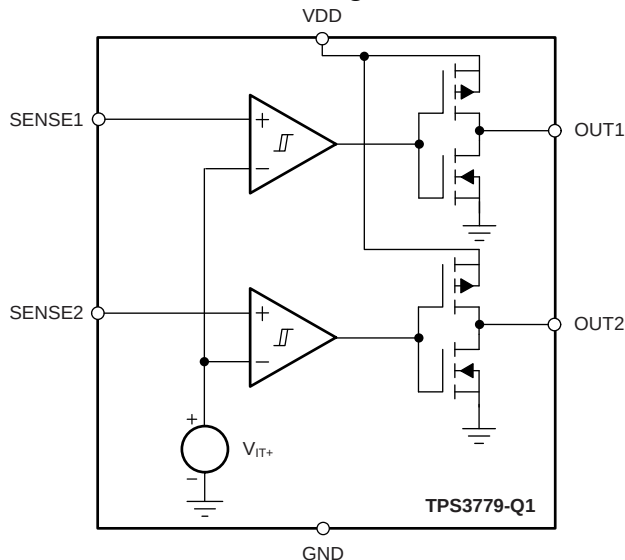
### 8.1 Overview

The TPS3779-Q1 and TPS3780-Q1 are small, low quiescent current ( $I_{DD}$ ), dual-channel voltage detectors. These devices have high-accuracy rising and falling input thresholds, and assert the output as shown in 表 1. The output (OUTx pin) goes low when the SENSEx pin is less than  $V_{IT-}$  and goes high when the pin is greater than  $V_{IT+}$ . The TPS3779-Q1 and TPS3780-Q1 offer two hysteresis options (5% and 10%) for use in a wide variety of applications. These devices have two independent voltage-detection channels that can be used in systems where multiple voltage rails are required to be monitored, or where one channel can be used as an early warning signal and the other channel can be used as the system reset signal.

**表 1. TPS3779-Q1, TPS3780-Q1 Truth Table**

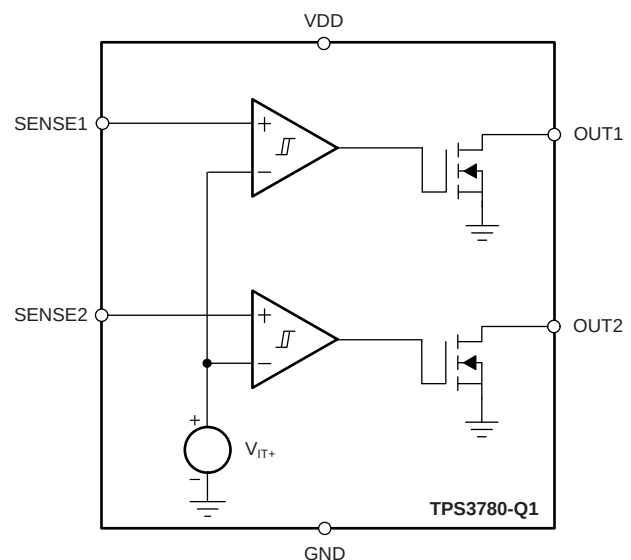
| CONDITIONS         | OUTPUT      |
|--------------------|-------------|
| SENSE1 < $V_{IT-}$ | OUT1 = low  |
| SENSE2 < $V_{IT-}$ | OUT2 = low  |
| SENSE1 > $V_{IT+}$ | OUT1 = high |
| SENSE2 > $V_{IT+}$ | OUT2 = high |

### 8.2 Functional Block Diagrams



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**图 20. TPS3779-Q1 Block Diagram**



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**图 21. TPS3780-Q1 Block Diagram**

## 8.3 Feature Description

### 8.3.1 Inputs (SENSE1, SENSE2)

The TPS3779-Q1 and TPS3780-Q1 each have two comparators for voltage detection. Each comparator has one external input; the other input is connected to the internal reference. The comparator rising threshold is designed and trimmed to be equal to  $V_{IT+}$ , and the falling threshold is trimmed to be equal to  $V_{IT-}$ . The built-in falling hysteresis options make the devices immune to supply rail noise and ensure stable operation.

The comparator inputs can swing from ground to 5.5 V, regardless of the device supply voltage used. Although not required in most cases, for extremely noisy applications, good analog design practice is to place a 1-nF to 10-nF bypass capacitor at the comparator input in order to reduce sensitivity to transients and layout parasitic.

For each SENSEx input, the corresponding output (OUTx) is driven to logic low when the input voltage drops below  $V_{IT-}$ . When the voltage exceeds  $V_{IT+}$ , the output (OUTx) is driven high; see [Figure 1](#).

### 8.3.2 Outputs (OUT1, OUT2)

In a typical device application, the outputs are connected to a reset or enable input of another device, such as a digital signal processor (DSP), central processing unit (CPU), field-programmable gate array (FPGA), or application-specific integrated circuit (ASIC); or the outputs are connected to the enable input of a voltage regulator, such as a dc-dc or low-dropout (LDO) regulator.

The TPS3779-Q1 provides two push-pull outputs. The logic high level of the outputs is determined by the VDD pin voltage. Pullup resistors are not required with this configuration, thus saving board space. However, all interface logic levels must be examined. All OUTx connections must be compatible with the VDD pin logic level.

The TPS3780-Q1 provides two open-drain outputs (OUT1 and OUT2); pullup resistors must be used to hold these lines high when the output goes to a high-impedance condition (not asserted). By connecting pullup resistors to the proper voltage rails, the outputs can be connected to other devices at correct interface voltage levels. The outputs can be pulled up to 5.5 V, independent of the device supply voltage. To ensure proper voltage levels, make sure to choose the correct pullup resistor values. The pullup resistor value is determined by  $V_{OL}$ , the sink current capability, and the output leakage current ( $I_{IKG(OD)}$ ). These values are specified in the [Electrical Characteristics](#) table. By using wired-AND logic, OUT1 and OUT2 can be combined into one logic signal. The [Inputs \(SENSE1, SENSE2\)](#) section describes how the outputs are asserted or deasserted. See [Figure 1](#) for a description of the relationship between threshold voltages and the respective output.

## 8.4 Device Functional Modes

### 8.4.1 Normal Operation ( $VDD \geq VDD(min)$ )

When the voltage on VDD is greater than VDD(min) for  $t_{SD}$ , the output signals react to the present state of the corresponding SENSEx pins.

### 8.4.2 Power-On-Reset ( $VDD < V_{(POR)}$ )

When the voltage on VDD is lower than the required voltage to internally pull the logic low output to GND ( $V_{(POR)}$ ), both outputs are undefined and are not to be relied upon for proper system function.

## 9 Application and Implementation

### 注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The TPS3779-Q1 and TPS3780-Q1 are used as precision, dual-voltage detectors. The monitored voltage, VDD voltage, and output pullup voltage (TPS3780-Q1 only) can be independent voltages or connected in any configuration.

#### 9.1.1 Threshold Overdrive

Threshold overdrive is how much  $V_{SENSE1}$  or  $V_{SENSE2}$  exceeds the specified threshold, and is important to know because a smaller overdrive results in a slower OUTx response. Threshold overdrive is calculated as a percent of the threshold in question, as shown in [公式 1](#):

$$\text{Overdrive} = | (V_{SENSE1,2} / V_{IT} - 1) \times 100\% |$$

where

- $V_{IT}$  is either  $V_{IT-}$  or  $V_{IT+}$ , depending on whether calculating the overdrive for the negative-going threshold or the positive-going threshold, respectively
- $V_{SENSE1,2}$  is the voltage at the SENSE1 or SENSE2 input

(1)

[图 16](#) illustrates the minimum detectable pulse on the SENSEx inputs versus overdrive, and is used to visualize the relationship that overdrive has on  $t_{PD(f)}$  for negative-going events.

#### 9.1.2 Sense Resistor Divider

The resistor divider values and target threshold voltage can be calculated by using [公式 2](#) and [公式 3](#) to determine  $V_{MON(UV)}$  and  $V_{MON(PG)}$ , respectively.

$$V_{MON(UV)} = \left( 1 + \frac{R1}{R2} \right) \times V_{IT-} \quad (2)$$

$$V_{MON(PG)} = \left( 1 + \frac{R1}{R2} \right) \times V_{IT+} \quad (3)$$

where

- R1 and R2 are the resistor values for the resistor divider on the SENSEx pins
- $V_{MON(UV)}$  is the target voltage at which an undervoltage condition is detected
- $V_{MON(PG)}$  is the target voltage at which the output goes high when  $V_{MONx}$  rises

Choose  $R_{TOTAL}$  (equal to  $R1 + R2$ ) so that the current through the divider is approximately 100 times higher than the input current at the SENSEx pins. The resistors can have high values to minimize current consumption as a result of low input bias current without adding significant error to the resistive divider. For details on sizing input resistors, see the [Optimizing Resistor Dividers at a Comparator Input](#) application report (SLVA450), available for download from [www.ti.com](http://www.ti.com).

## 9.2 Typical Applications

### 9.2.1 Monitoring Two Separate Rails

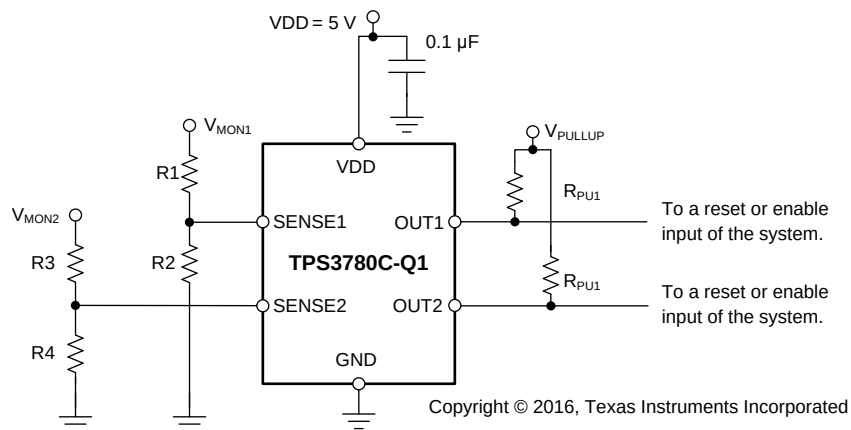


图 22. Monitoring Two Separate Rails Schematic

#### 9.2.1.1 Design Requirements

表 2. Design Parameters

| PARAMETER            | DESIGN REQUIREMENT                                             | DESIGN RESULT                                    |
|----------------------|----------------------------------------------------------------|--------------------------------------------------|
| VDD                  | 5 V                                                            | 5 V                                              |
| Hysteresis           | 10%                                                            | 10%                                              |
| Monitored voltage 1  | 3.3 V nominal, $V_{MON(PG)} = 2.9$ V,<br>$V_{MON(UV)} = 2.6$ V | $V_{MON(PG)} = 2.908$ V, $V_{MON(UV)} = 2.618$ V |
| Monitored voltage 2  | 3 V nominal, $V_{MON(PG)} = 2.6$ V,<br>$V_{MON(UV)} = 2.4$ V   | $V_{MON(PG)} = 2.606$ V, $V_{MON(UV)} = 2.371$ V |
| Output logic voltage | 3.3-V CMOS                                                     | 3.3-V CMOS                                       |

#### 9.2.1.2 Detailed Design Procedure

- Select the TPS3780C-Q1. The C version is selected to satisfy the hysteresis requirement. The TPS3780-Q1 is selected for the output logic requirement. An open-drain output allows for the output to be pulled up to a voltage other than VDD.
- The resistor divider values are calculated by using 公式 2 and 公式 3. For SENSE1,  $R1 = 1.13$  M $\Omega$  and  $R2 = 787$  k $\Omega$ . For SENSE2,  $R3 (R1) = 681$  k $\Omega$  and  $R4 (R2) = 576$  k $\Omega$ .

#### 9.2.1.3 Application Curve

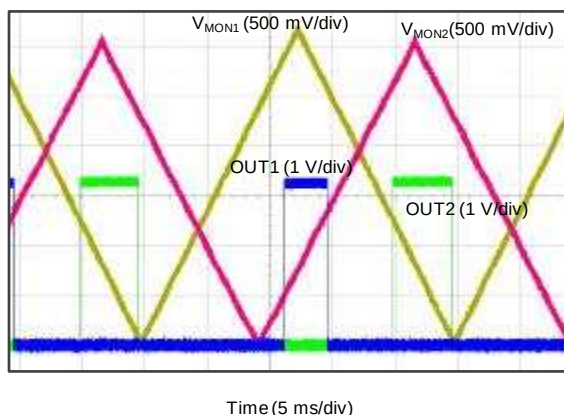
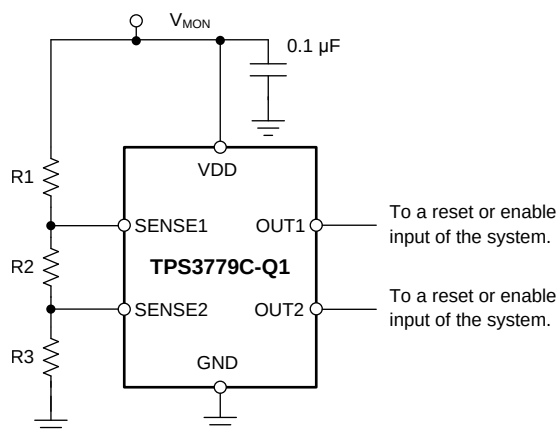


图 23. Monitoring Two Separate Rails Curve

## 9.2.2 Early Warning Detection



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**图 24. Early Warning Detection Schematic**

### 9.2.2.1 Design Requirements

**表 3. Design Parameters**

| PARAMETER           | DESIGN REQUIREMENT                                            | DESIGN RESULT                                                     |
|---------------------|---------------------------------------------------------------|-------------------------------------------------------------------|
| VDD                 | $V_{MON}$                                                     | $V_{MON}$                                                         |
| Hysteresis          | 10%                                                           | 10%                                                               |
| Monitored voltage 1 | $V_{MON(PG)} = 3.3 \text{ V}$ , $V_{MON(UV)} = 3 \text{ V}$   | $V_{MON(PG)} = 3.330 \text{ V}$ , $V_{MON(UV)} = 2.997 \text{ V}$ |
| Monitored voltage 2 | $V_{MON(PG)} = 3.9 \text{ V}$ , $V_{MON(UV)} = 3.5 \text{ V}$ | $V_{MON(PG)} = 3.921 \text{ V}$ , $V_{MON(UV)} = 3.529 \text{ V}$ |

### 9.2.2.2 Detailed Design Procedure

1. Select the TPS3779C-Q1. The C version is selected to satisfy the hysteresis requirement. The TPS3779-Q1 is selected to save on component count and board space.
2. Use 公式 4 to calculate the total resistance for the resistor divider. Determine the minimum total resistance of the resistor network necessary to achieve the current consumption specification. For this example, the current flow through the resistor network is chosen to be  $1.41 \mu\text{A}$ . Use the key transition point for  $V_{MON2}$ . For this example, the low-to-high transition,  $V_{MON(PG)}$ , is considered more important.

$$R_{TOTAL} = \frac{V_{MON(PG\_2)}}{I} = \frac{3.9 \text{ V}}{1.41 \mu\text{A}} = 2.78 \text{ M}\Omega$$

where

- $V_{MON(PG\_2)}$  is the target voltage at which OUT2 goes high when  $V_{MON}$  rises
- $I$  is the current flowing through the resistor network

3. After  $R_{TOTAL}$  is determined, R3 can be calculated using 公式 5. Select the nearest 1% resistor value for R3. In this case, 845 kΩ is the closest value.

$$R3 = \frac{V_{IT+}}{I} = \frac{1.194 \text{ V}}{1.41 \mu\text{A}} = 846 \text{ k}\Omega$$

4. Use 公式 6 to calculate R2. Select the nearest 1% resistor value for R2. In this case, 150 kΩ is the closest value. Use the key transition point for  $V_{MON1}$ . For this example, the high-to-low transition,  $V_{MON(UV)}$ , is considered more important.

$$R2 = \frac{R_{TOTAL}}{V_{MON(UV\_1)}} \cdot V_{IT-} - R3 = \frac{2.78 \text{ M}\Omega}{3 \text{ V}} \cdot 1.074 \text{ V} - 845 \text{ k}\Omega = 149 \text{ k}\Omega$$

where

- $V_{MON(UV\_1)}$  is the target voltage at which OUT1 goes low when  $V_{MON}$  falls

5. Use 公式 7 to calculate R1. Select the nearest 1% resistor value for R1. In this case, 1.78 MΩ is a 1% resistor.

$$R1 = R_{TOTAL} - R2 - R3 = 2.78 \text{ M}\Omega - 150 \text{ k}\Omega - 845 \text{ k}\Omega = 1.78 \text{ M}\Omega \quad (7)$$

### 9.2.2.3 Application Curve

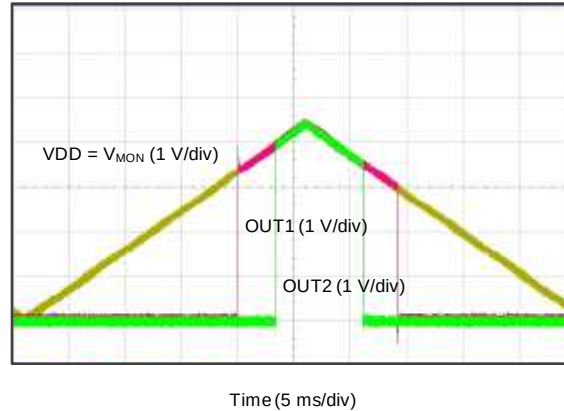


图 25. Early Warning Detection Curve

## 10 Power-Supply Recommendations

The TPS3779-Q1 and TPS3780-Q1 are designed to operate from an input voltage supply range between 1.5 V and 5.5 V. An input supply capacitor is not required for this device; however, good analog practice is to place a 0.1-μF or greater capacitor between the VDD pin and the GND pin. This device has a 7-V absolute maximum rating on the VDD pin. If the voltage supply providing power to VDD is susceptible to any large voltage transient that can exceed 7 V, additional precautions must be taken.

For applications where SENSEx is greater than 0 V before VDD, and is subject to a startup slew rate of less than 200 mV per 1 ms, the output can be driven to logic high in error. To correct the output, cycle the SENSEx lines below V<sub>IT-</sub> or sequence SENSEx after VDD.

## 11 Layout

### 11.1 Layout Guidelines

Place the VDD decoupling capacitor close to the device.

Avoid using long traces for the VDD supply node. The VDD capacitor, along with parasitic inductance from the supply to the capacitor, can form an LC tank circuit that creates ringing with peak voltages above the maximum VDD voltage.

### 11.2 Layout Example

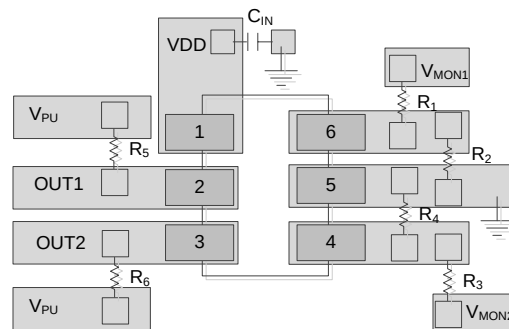


图 26. Example SOT-23 Layout

## 12 器件和文档支持

### 12.1 器件支持

#### 12.1.1 开发支持

##### 12.1.1.1 评估模块

评估模块 (EVM) 可与 TPS3779-Q1 和 TPS3780-Q1 配套使用，帮助评估初始电路性能。[TPS3780EVM-154 评估模块](#)详细介绍了 TPS3780EVM-154 的设计套件和评估模块。

EVM 可通过[德州仪器 \(TI\)](#) 网站上的 [TPS3779-Q1](#) 和 [TPS3780-Q1](#) 产品文件夹获取，也可直接从 [TI 网上商店](#) 购买。

##### 12.1.1.2 Spice 模型

分析模拟电路和系统的性能时，使用 SPICE 模型对电路性能进行计算机仿真非常有用。您可以从相应器件产品文件夹中的仿真模型下获取 TPS3779-Q1 和 TPS3780-Q1 的 SPICE 模型。

#### 12.1.2 器件命名规则

TPS3779xQyyyyzQ1 和 TPS3780xQyyyyzQ1 是这些器件的通用命名约定。TPS3779-Q1 和 TPS3780-Q1 代表此类器件所属系列；x 用于表示滞后版本，yyy 预留给封装标识符，z 为封装数量。

- 示例：TPS3780CDBVRQ1
- 系列：TPS3780-Q1（开漏）
- 滞后：10%
- DBV 封装：6 引脚小外形尺寸晶体管 (SOT)-23
- 封装数量：R 表示 3000 片

### 12.2 文档支持

#### 12.2.1 相关文档

相关文档如下：

- [《TPS3780EVM-154 评估模块》](#)（文献编号：SLVU796）
- [应用报告《优化比较器输入端的电阻分压器》](#)（文献编号：SLVA450）

#### 12.3 接收文档更新通知

如需接收文档更新通知，请访问 [www.ti.com.cn](#) 网站上的器件产品文件夹。点击右上角的提醒我 (Alert me) 注册后，即可每周定期收到已更改的产品信息。有关更改的详细信息，请查阅已修订文档中包含的修订历史记录。

### 12.4 相关链接

下面的表格列出了快速访问链接。范围包括技术文档、支持与社区资源、工具和软件，并且可以快速访问样片或购买链接。

表 4. 相关链接

| 器件         | 产品文件夹                 | 样片与购买                 | 技术文档                  | 工具与软件                 | 支持与社区                 |
|------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|
| TPS3779-Q1 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |
| TPS3780-Q1 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |



## 12.5 社区资源

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

## 12.6 商标

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

## 12.7 静电放电警告



ESD 可能会损坏该集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理措施和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

## 12.8 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本文档进行修订的情况下发生改变。欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

## PACKAGING INFORMATION

| Orderable part number             | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TPS3779BQDBVRQ1</a>   | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12OE                |
| TPS3779BQDBVRQ1.B                 | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12OE                |
| <a href="#">TPS3779BQDBVRQ1G4</a> | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12OE                |
| TPS3779BQDBVRQ1G4.B               | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12OE                |
| <a href="#">TPS3779CQDBVRQ1</a>   | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12PE                |
| TPS3779CQDBVRQ1.B                 | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12PE                |
| <a href="#">TPS3780AQDBVRQ1</a>   | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12FE                |
| TPS3780AQDBVRQ1.B                 | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12FE                |
| <a href="#">TPS3780BQDBVRQ1</a>   | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12GE                |
| TPS3780BQDBVRQ1.B                 | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12GE                |
| <a href="#">TPS3780CQDBVRQ1</a>   | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12HE                |
| TPS3780CQDBVRQ1.B                 | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 12HE                |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

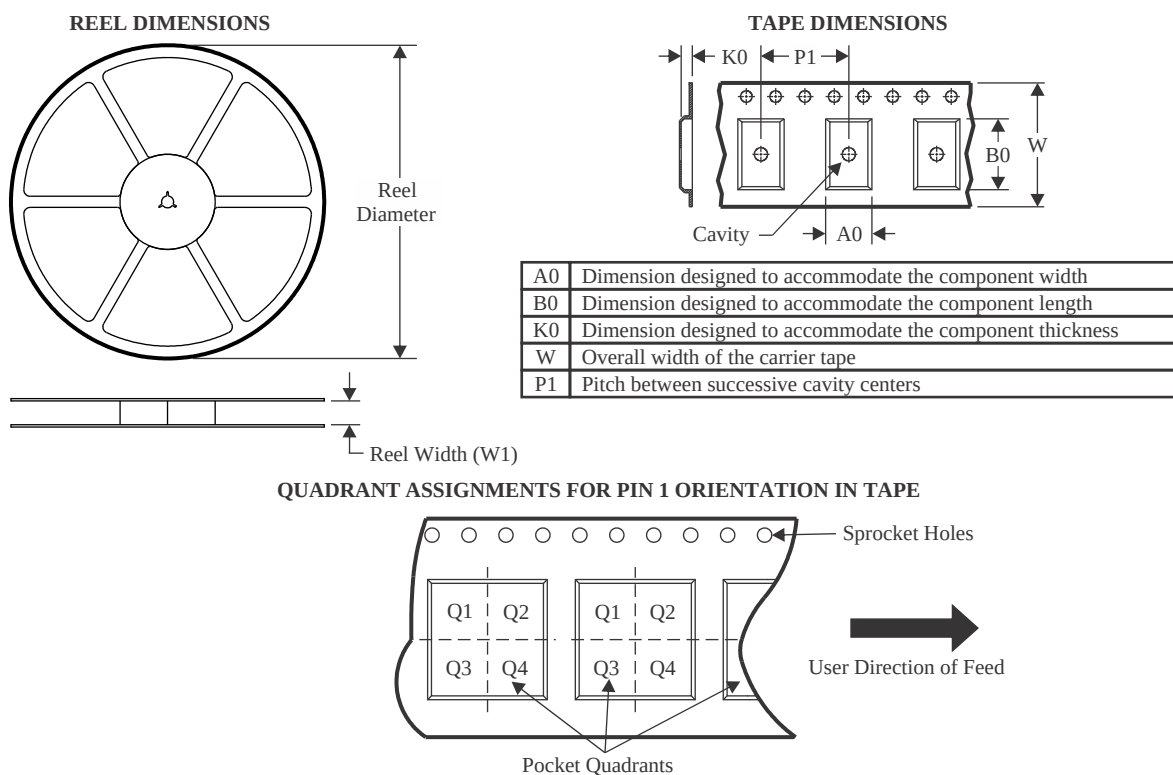
**OTHER QUALIFIED VERSIONS OF TPS3779-Q1, TPS3780-Q1 :**

- Catalog : [TPS3779](#), [TPS3780](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

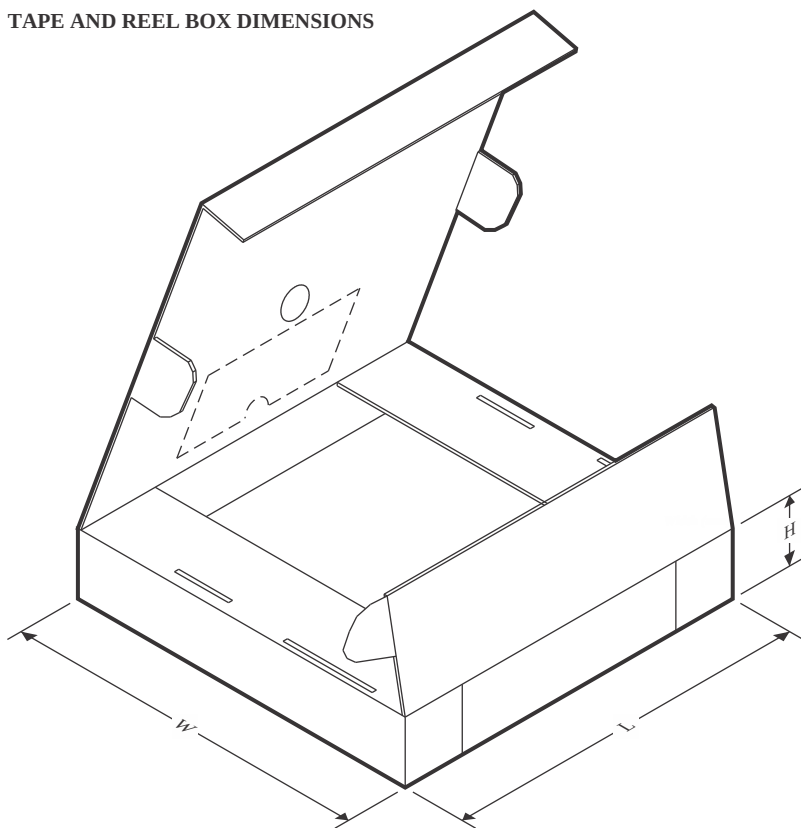
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS3779BQDBVRQ1   | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS3779BQDBVRQ1G4 | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS3779CQDBVRQ1   | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS3780AQDBVRQ1   | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS3780BQDBVRQ1   | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS3780CQDBVRQ1   | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS3779BQDBVRQ1   | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3779BQDBVRQ1G4 | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3779CQDBVRQ1   | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3780AQDBVRQ1   | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3780BQDBVRQ1   | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3780CQDBVRQ1   | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |



## SOT-23 - 1.45 mm max height

## SMALL OUTLINE TRANSISTOR



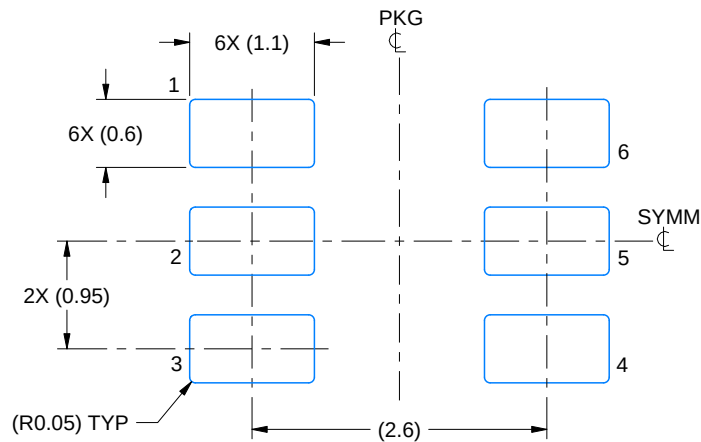
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.25 per side.
4. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
5. Reference JEDEC MO-178.

# EXAMPLE BOARD LAYOUT

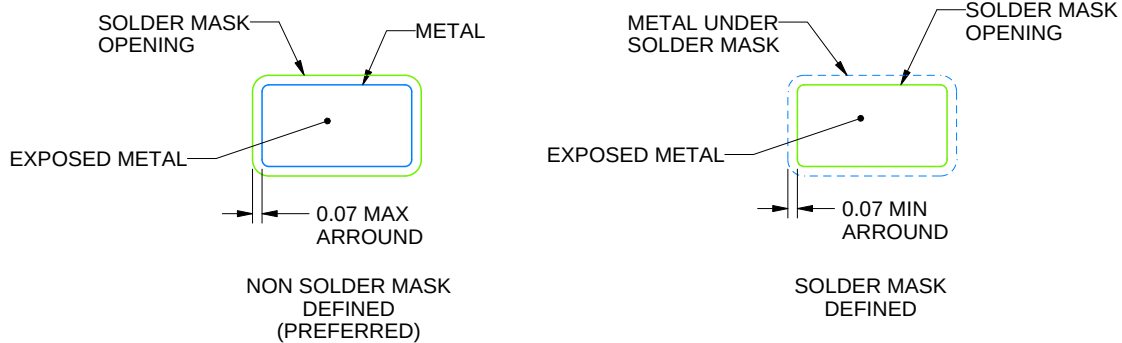
DBV0006A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

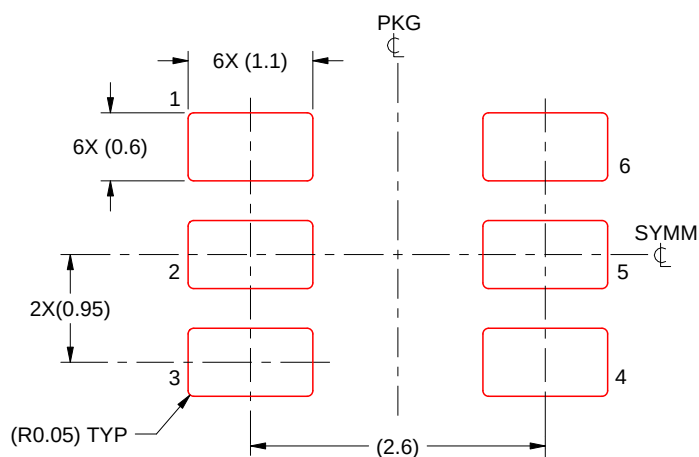
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0006A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



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